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CY2DM1502

1:2 CML Fanout Buffer with Selectable Clock Input

Features

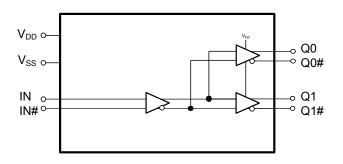
- One current mode logic (CML), High-speed current steering logic (HCSL), or low-voltage positive emitter-coupled logic (LVPECL) input pair distributed to two CML output pairs
- 20-ps maximum output-to-output skew
- 480-ps maximum propagation delay
- 0.15-ps maximum additive RMS phase jitter at 156.25 MHz (12-kHz to 20-MHz offset)
- Up to 1.5 GHz operation
- 8-pin thin shrunk small outline package (TSSOP) package
- 2.5-V or 3.3-V operating voltage ^[1]
- Commercial and industrial operating temperature range

Logic Block Diagram

Functional Description

The CY2DM1502 is an ultra-low noise, low-skew, low-propagation delay 1:2 CML, HCSL, or LVPECL to CML fanout buffer targeted to meet the requirements of high-speed clock distribution applications. The device has a fully differential internal architecture that is optimized to achieve low additive jitter and low skew at operating frequencies of up to 1.5 GHz.

For a complete list of related documentation, click here.



Note

1. Input AC-coupling capacitors are required for voltage-translation applications.



CY2DM1502

Contents

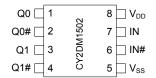
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Pinouts

Figure 1. 8-pin TSSOP Package pinout



Pin Definitions

Pin No.	Pin Name	Pin Type	Description
1, 3	Q(0:1)	Output	CML output clocks
2, 4	Q(0:1)#	Output	CML complementary output clocks
5	V _{SS}	Power	Ground
6	IN#	Input	CML/HCSL/LVPECL complementary input clock
7	IN	Input	CML/HCSL//LVPECL input clock
8	V _{DD}	Power	Power supply



Absolute Maximum Ratings

Parameter	Description	Condition	Min	Max	Unit
V _{DD}	Supply voltage	Nonfunctional	-0.5	4.6	V
V _{IN} ^[2]	Input voltage, relative to V_{SS}	Nonfunctional	-0.5	lesser of 4.0 or V _{DD} + 0.4	V
V _{OUT} ^[2]	DC output or I/O voltage, relative to V_{SS}	Nonfunctional	-0.5	lesser of 4.0 or V _{DD} + 0.4	V
Τ _S	Storage temperature	Nonfunctional	-55	150	°C
ESD _{HBM}	Electrostatic discharge (ESD) protection (Human body model)	JEDEC STD 22-A114-B	2000	-	V
LU	Latch up		Meets or exceeds JEDEC Spec JESD78B IC Latch-up Test		
UL-94	Flammability rating	At 1/8 in	V-0		
MSL	Moisture sensitivity level		3		

Operating Conditions

Parameter	Description	Condition	Min	Max	Unit
V _{DD}	Supply voltage	2.5-V supply	2.375	2.625	V
		3.3-V supply	3.135	3.465	V
T _A	Ambient operating temperature	Commercial	0	70	°C
		Industrial	-40	85	°C
t _{PU}	Power ramp time	Power-up time for V _{DD} to reach minimum specified voltage (power ramp must be monotonic).	0.05	500	ms



DC Electrical Specifications

(V_{DD} = 3.3 V ± 5% or 2.5 V ± 5%; T_A = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

Parameter	Description	Condition	Min	Max	Unit
I _{DD}	Operating supply current	All CML outputs floating (internal I _{DD})	-	50	mA
V _{IH}	Input high voltage, CML/HCSL/LVPECL inputs IN and IN#		-	V _{DD} + 0.3	V
V _{IL}	Input low voltage, CML/HCSL/LVPECL inputs IN and IN#		-0.3	_	V
V _{ID} ^[3]	Input differential amplitude	See Figure 2 on page 7	0.4	1.0	V
V _{ICM}	Input common mode voltage	See Figure 2 on page 7	0.2	V _{DD} – 0.2	V
I _{IH}	Input high current, CML/HCSL/LVPECL inputs IN and IN#	Input = $V_{DD}^{[4]}$	-	150	μΑ
I _{IL}	Input low current, CML/HCSL/LVPECL inputs IN and IN#	Input = $V_{SS}^{[4]}$	-150	_	μΑ
V _{OH}	CML output high voltage	Terminated with 50 Ω to V _{DD} ^[5]	V _{DD} – 0.1	-	V
V _{OL}	CML output low voltage	Terminated with 50 Ω to V _{DD} ^[5]	V _{DD} – 0.7	V _{DD} – 0.3	V
C _{IN}	Input capacitance	Measured at 10 MHz; per pin	-	3	pF

Thermal Resistance

Parameter [6]	Description	Test Conditions	8-pin TSSOP	Unit
θ_{JA}	0	Test conditions follow standard test methods and procedures for measuring thermal impedance, in	162	°C/W
θ_{JC}	Thermal resistance (junction to case)	accordance with EIA/JESD51.	29	°C/W

Notes

- V_{ID} minimum of 400 mV is required to meet all output AC Electrical Specifications. The device is functional with V_{ID} minimum of greater than 200 mV.
 Positive current flows into the input pin, negative current flows out of the input pin.
- 5. Refer to Figure 3 on page 7.
- 6. These parameters are guaranteed by design and are not tested.





AC Electrical Specifications

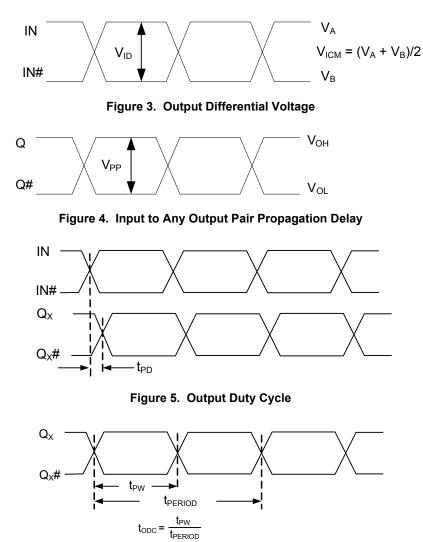
(V_{DD} = 3.3 V ± 5% or 2.5 V ± 5%; T_A = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

Parameter	Description	Condition	Min	Тур	Max	Unit
F _{IN}	Input frequency		DC	-	1.5	GHz
F _{OUT}	Output frequency	F _{OUT} = F _{IN}	DC	-	1.5	GHz
V _{PP}	CML differential output voltage	Fout = DC to 150 MHz	250	-	700	mV
	peak-to-peak, single-ended. Terminated with 50 Ω to $\mathrm{V_{DD}}^{[5]}$	Fout = >150 MHz to 1.5 GHz	250	_	600	mV
t _{PD} ^[7]	Propagation delay input pair to output pair	Input rise/fall time < 1.5 ns (20% to 80%)	-	-	480	ps
t _{ODC} ^[8]	Output duty cycle	50% duty cycle at input Frequency range up to 1 GHz	48	-	52	%
t _{SK1} ^[9]	Output-to-output skew	Any output to any output, with same load conditions at DUT	-	_	20	ps
t _{SK1 D} ^[9]	Device-to-device output skew	Any output to any output between two or more devices. Devices must have the same input and have the same output load.	-	-	150	ps
PN _{ADD}	Additive RMS phase noise 156.25-MHz Input	Offset = 1 kHz	-	-	-120	dBc/ Hz
	Rise/fall time < 150 ps (20% to 80%)	Offset = 10 kHz	-	-	-130	dBc/ Hz
	V _{ID} > 400 mV	Offset = 100 kHz	-	-	-135	dBc/ Hz
		Offset = 1 MHz	-	-	-145	dBc/ Hz
		Offset = 10 MHz	-	-	-153	dBc/ Hz
		Offset = 20 MHz	-	-	-155	dBc/ Hz
t _{JIT} ^[10]	Additive RMS phase jitter (Random)	156.25 MHz, 12 kHz to 20 MHz offset; input rise/fall time < 150 ps (20% to 80%), V _{ID} > 400 mV	-	_	0.15	ps
t _R , t _F ^[11]	Output rise/fall time	50% duty cycle at input, 20% to 80% of full swing $(V_{OL} \text{ to } V_{OH})$ Input rise/fall time < 1.5 ns (20% to 80%) Measured at 1 GHz	-	-	250	ps

Notes











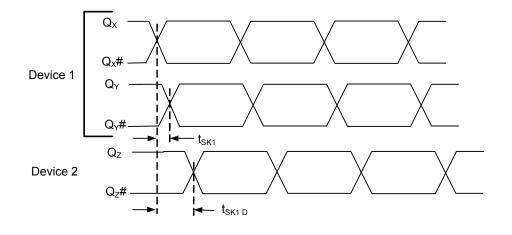
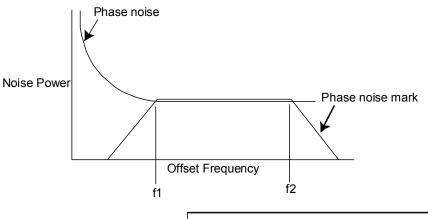
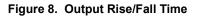


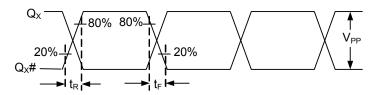
Figure 6. Output-to-Output and Device-to-Device Skew





RMS Jitter $\propto \sqrt{\text{Area Under the Masked Phase Noise Plot}}$



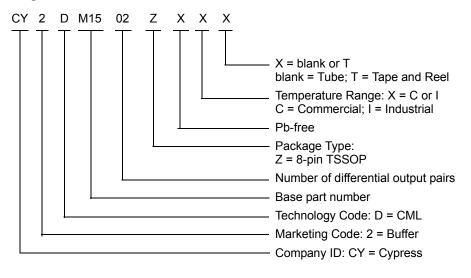




Ordering Information

Part Number	Туре	Production Flow
Pb-free		
CY2DM1502ZXI	8-pin TSSOP	Industrial, –40 °C to 85 °C
CY2DM1502ZXIT	8-pin TSSOP tape and reel	Industrial, –40 °C to 85 °C

Ordering Code Definitions



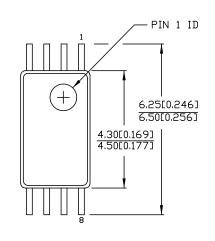




Package Diagram

Figure 9. 8-pin TSSOP (4.40 MM Body) Z08.173/ZZ08.173 Package Outline, 51-85093

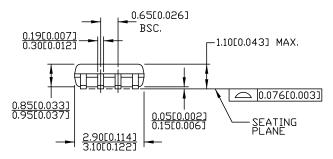
8 Lead TSSOP 4.40 MM BODY

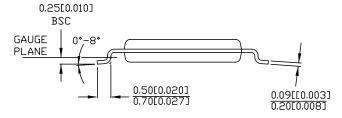


DIMENSIONS IN MMEINCHES] <u>Min.</u> Max.

REFERENCE JEDEC MO-153

	PART #
Z08.173	STANDARD PKG.
ZZ08.173	LEAD FREE PKG.





51-85093 *E





Acronyms

Table 1. Acronyms Used in this Document

Acronym	Description
CML	current mode logic
ESD	electrostatic discharge
HBM	human body model
HCSL	high-speed current steering logic
JEDEC	joint electron devices engineering council
LVDS	low-voltage differential signal
LVCMOS	low-voltage complementary metal oxide semiconductor
LVPECL	low-voltage positive emitter-coupled logic
RMS	root mean square
TSSOP	thin shrunk small outline package

Document Conventions

Units of Measure

Table 2. Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
dBc	decibels relative to the carrier
GHz	gigahertz
Hz	hertz
kΩ	kilohm
μA	microampere
μF	microfarad
μs	microsecond
mA	milliampere
ms	millisecond
mV	millivolt
MHz	megahertz
ns	nanosecond
Ω	ohm
pF	picofarad
ps	picosecond
V	volt
W	watt



Document History Page

Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	2782891	CXQ	10/09/09	New Datasheet.
*A	2838916	CXQ	01/05/2010	Changed status from "ADVANCE" to "PRELIMINARY". Changed from 0.34 ps to 0.25 ps maximum additive jitter in "Features" on page 1 and in t _{JIT} in the AC Electrical Specs table on page 4. Added t _{PU} spec to the Operating Conditions table on page 2. Removed V _{OH} spec maximum of V _{DD} in the DC Electrical Specs table on page 3. Changed V _{OL} spec min from V _{DD} - 0.6V to V _{DD} - 0.7V; changed max from V _{DI} - 0.4V to V _{DD} - 0.3V in the DC Electrical Specs table on page 3. Removed V _{OD} spec of minimum 300 mV, maximum 450 mV in the DC Electrical Specs table on page 3. Added R _P spec in the DC Electrical Specs table on page 3. Min = 60 k Ω , Max = 140 k Ω . Added a measurement definition for C _{IN} in the DC Electrical Specs table on page 3. Added V _{PP} spec to the AC Electrical Specs table on page 4. V _{PP} max = 700 mV for DC - 150 MHz and max = 600 mV for 150 MHz to 1.5 GHz. V _{PP} min = 250 mV over the entire range. Changed letter case and some names of all the timing parameters in the AC Electrical Specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 4. Added condition to t _R and t _F specs in the AC Electrical specs table on page 3. (Added condition to t _R and t _F specs in the AC Electrical spec
*В	3011766	CXQ	08/20/2010	Changed from 0.25 ps to 0.11 ps maximum additive jitter in "Features" on page 1 and in t_{JIT} in the AC Electrical Specs table. Added note 3 to describe I_{IH} and I_{IL} specs. Removed reference to data distribution from "Functional Description". Changed R_p for diff inputs from 100 k Ω to 150 k Ω in the Logic Block Diagran and from 60 k Ω min / 140 k Ω max to 90 k Ω min / 210 k Ω max in the DC Electrical Specs table. Added max V _{ID} of 1.0V in DC Electrical Specs table. Updated phase noise specs for 1 k/10 k/100 k/1 M/10 M/20 MHz offset to -120/-130/-135/-150/-150dBc/Hz, respectively, in the AC Electrical Spec table. Added "Frequency range up to 1 GHz" condition to t _{ODC} spec. Updated package diagram. Added Acronyms and Ordering Code Definition.
*C	3017258	CXQ	08/27/2010	Corrected Output Rise/Fall time diagram.
*D	3100234	CXQ	11/18/2010	Updated Phase jitter to 0.15ps max from 0.11ps max. Changed V _{IN} and V _{OUT} specs from 4.0V to "lesser of 4.0 or V _{DD} + 0.4" Removed 200mA min LU spec, replaced with "Meets or exceeds JEDEC Spec JESD78B IC Latchup Test" Removed R _P spec for differential input clock pins IN _X and IN _X #. Changed C _{IN} condition to "Measured at 10 MHz". Changed PN _{ADD} specs for 1MHz, 10MHz, and 20MHz offsets. Added condition "Measured at 1 GHz" to t _R , t _F specs.
*E	3137726	CXQ	01/13/2011	Removed "Preliminary" status heading. Removed resistors from IN/IN# in Logic Block Diagram.
*F	3090938	CXQ	02/25/2011	Post to external web.



Document History Page (continued)

Document Title: CY2DM1502, 1:2 CML Fanout Buffer with Selectable Clock Input Document Number: 001-56315							
Revision	ECN	Orig. of Change	Submission Date	Description of Change			
*G	3410372	PURU	10/18/2011	Adding HCSL to Features, Functional Description, Pin Definitions, and DC Electrical Specifications sections. The min value of V_{ICM} is changed from 0.5 to 0.2 in DC Electrical Specifications.			
*H	3878396	PURU	01/21/2013	Updated to new template.			
*	4587249	PURU	12/04/2014	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end. Updated Ordering Information: Removed the prune part numbers CY2DM1502ZXC and CY2DM1502ZXCT. Updated Package Diagram: spec 51-85093 – Changed revision from *D to *E.			
*J	5272915	PSR	05/16/2016	Added Thermal Resistance. Updated to new template.			



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